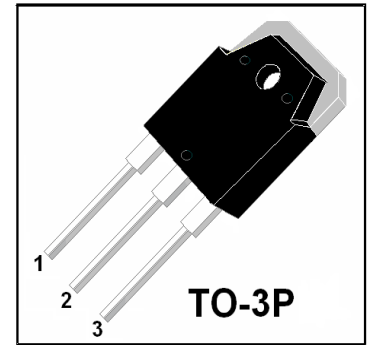


## PRODUCT FEATURES

- Ultrafast Recovery Time
- Low Recovery Loss
- Soft Reverse Recovery Characteristics
- Low Leakage Current
- Low Forward Voltage
- High Surge Current Capability

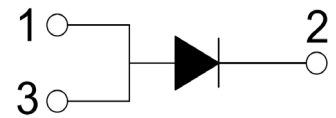
## APPLICATIONS

- Freewheeling, Snubber, Clamp
- Inversion Welder
- PFC
- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper
- UPS



## DESCRIPTION

FRED from MacMic utilizes advanced processing techniques to achieve ultrafast recovery times and higher forward current. Its soft recovery characteristics and high reliability suit for wide industrial applications.



## ABSOLUTE MAXIMUM RATINGS

$T_C = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
$V_R$	Maximum D.C. Reverse Voltage		300	V
$V_{RRM}$	Maximum Repetitive Reverse Voltage			
$I_{F(AV)}$	Average Forward Current	$T_C = 100^\circ\text{C}$	80	A
$I_{F(RMS)}$	RMS Forward Current	$T_C = 100^\circ\text{C}$	110	
$I_{FSM}$	Non-Repetitive Surge Forward Current	$T_J = 45^\circ\text{C}, t = 10\text{ms}, 50\text{Hz}, \text{Sine}$	640	
$P_D$	Power Dissipation		250	W
$T_J$	Junction Temperature		-55 to +150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range		-55 to +150	$^\circ\text{C}$
<b>Torque</b>	Module-to-Sink	Recommended (M3)	1.1	N.m
$R_{\theta JC}$	Junction-to-Case Thermal Resistance		0.5	$^\circ\text{C}/\text{W}$
<b>Weight</b>			6	g

## ELECTRICAL CHARACTERISTICS

$T_C = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$I_{RM}$	Maximum Reverse Leakage Current	$V_R = 300\text{V}$			10	$\mu\text{A}$
		$V_R = 300\text{V}, T_J = 125^\circ\text{C}$			10	mA
$V_F$	Forward Voltage	$I_F = 80\text{A}$		1.35	1.5	V
		$I_F = 80\text{A}, T_J = 125^\circ\text{C}$		1.25		
<b>trr</b>	Reverse Recovery Time ( $I_F = 1\text{A}, diF/dt = -200\text{A}/\mu\text{s}, V_R = 30\text{V}$ )			30		ns
<b>trr</b>	Reverse Recovery Time			50		ns
$I_{RRM}$	Maximum Reverse Recovery Current			5		A
<b>trr</b>	Reverse Recovery Time			95		ns
$I_{RRM}$	Maximum Reverse Recovery Current			9		A
<b>S</b>				0.6		

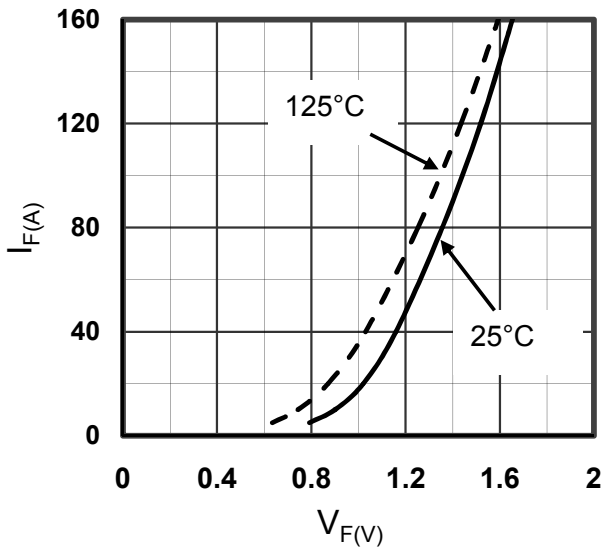


Figure1. Forward Voltage Drop vs Forward Current

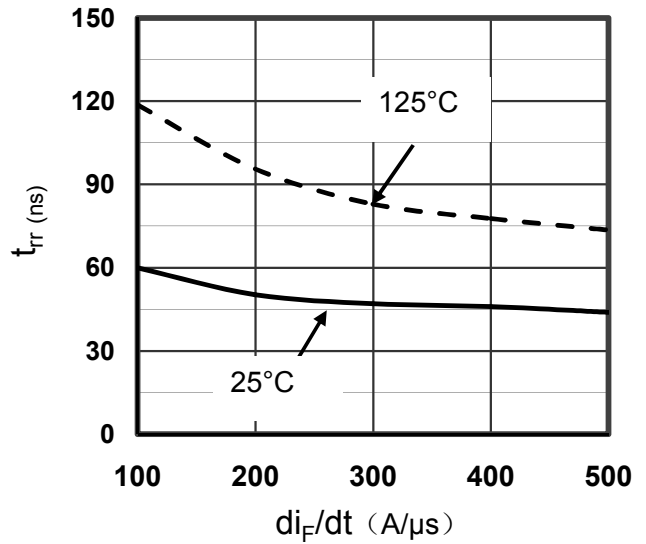


Figure2. Reverse Recovery Time vs diF/dt

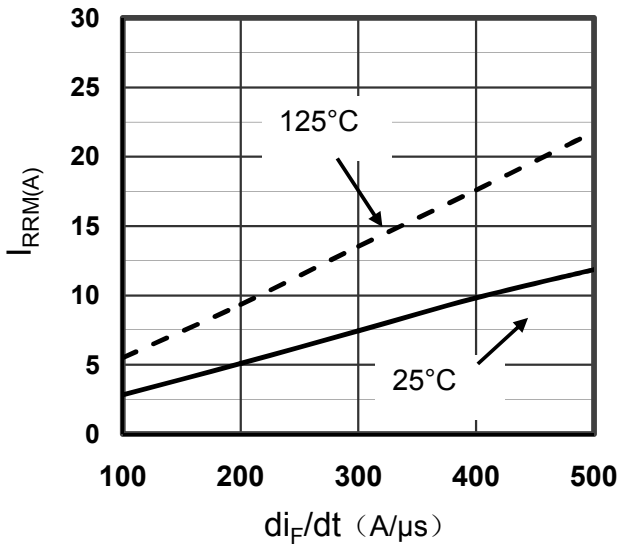


Figure3. Reverse Recovery Current vs diF/dt

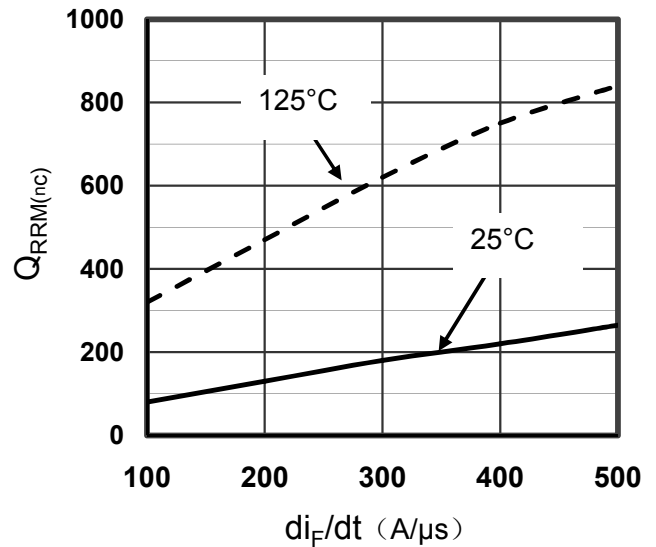


Figure4. Reverse Recovery Charge vs diF/dt

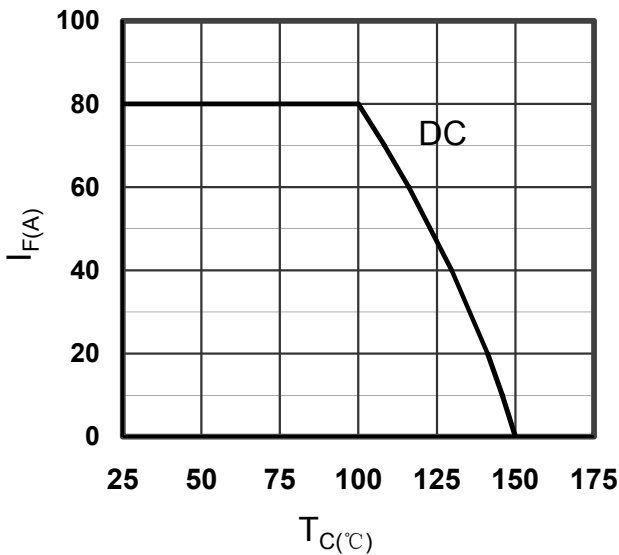


Figure5. Forward current vs Case temperature

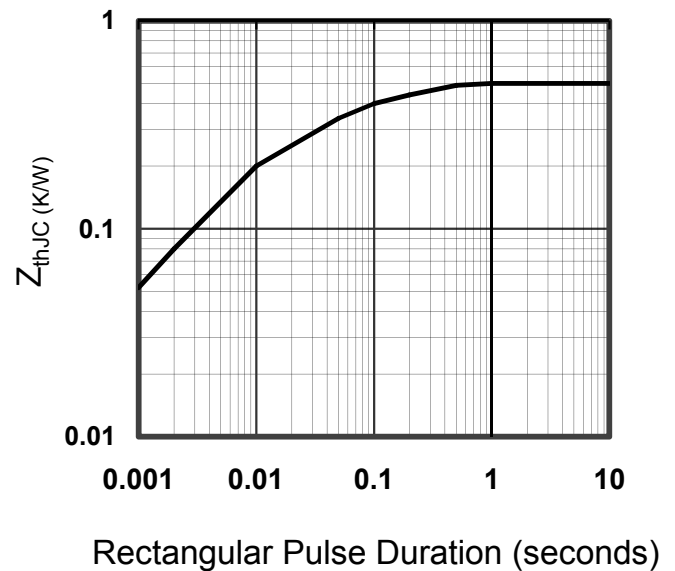


Figure6. Transient Thermal Impedance<sub>2</sub>

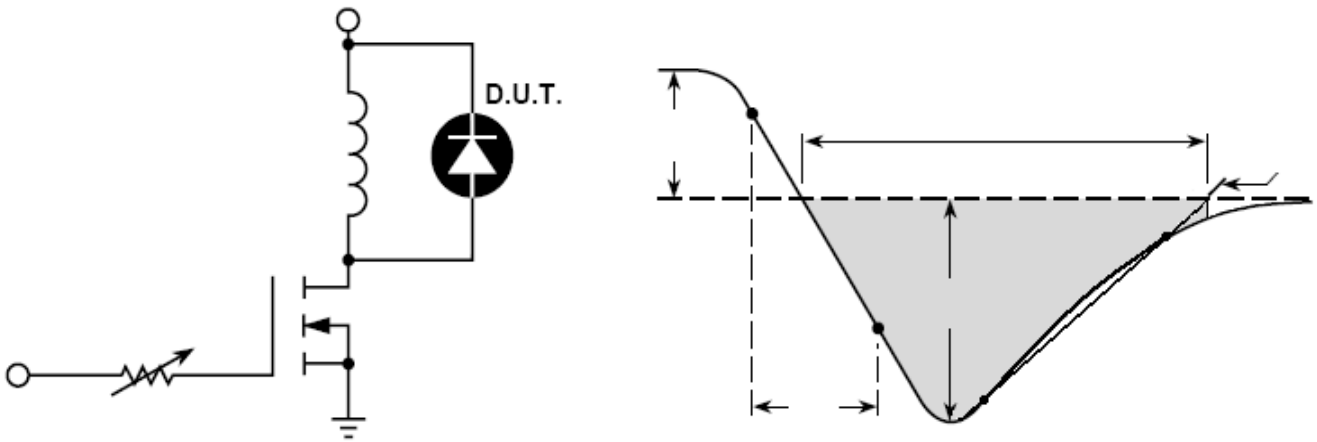
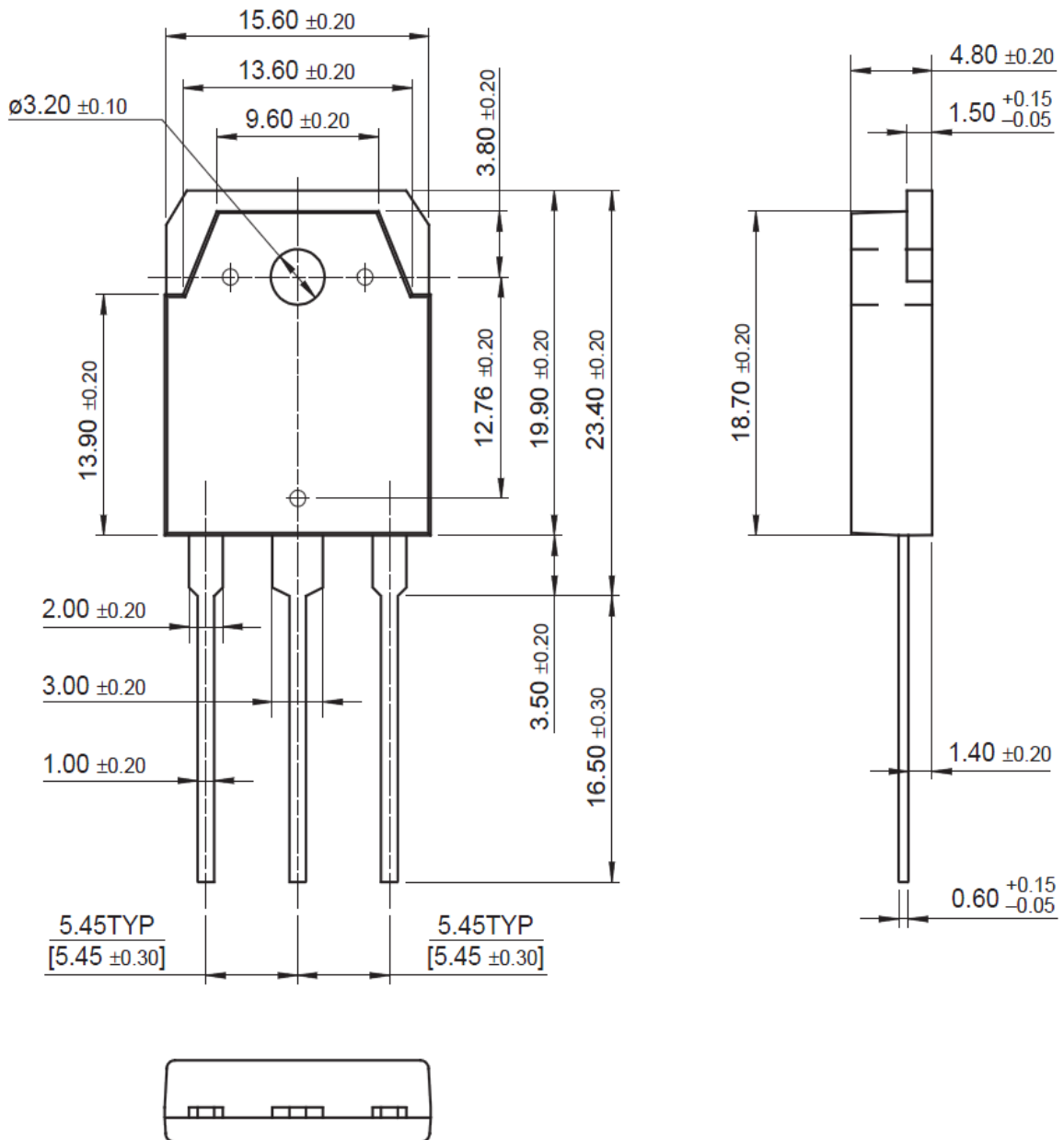


Figure7. Diode Reverse Recovery Test Circuit and Waveform



Dimensions in Millimeters and (Inchs)  
Figure8. Package Outline